



STM visualization of the growth of Ge nanostructures on Si(111)

Anna Sgarlata,

M. Scarselli,

A. Balzarotti

INFM-Università di Roma Tor Vergata

N. Motta

INFM-Università di Roma 3

F. Rosei

University of Aarhus, Denmark





Outline

- ✓ **Physical topics**
- ✓ **Experimental Apparatus**
- ✓ **Results**
- ✓ **Conclusions**





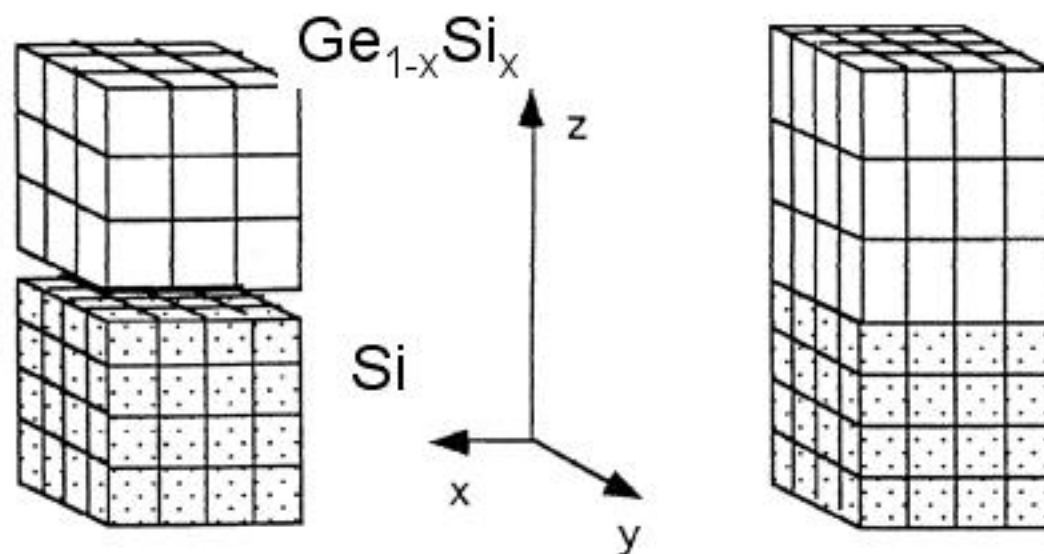
Aim

- ✓ **Growth and characterization of self-assembled quantum dots of Ge on Si(111)**
- ✓ **Determination of the influence of some experimental parameters on the kinetic of the growth**





Heteroepitaxy: atomic species are deposited on a substrate with different composition



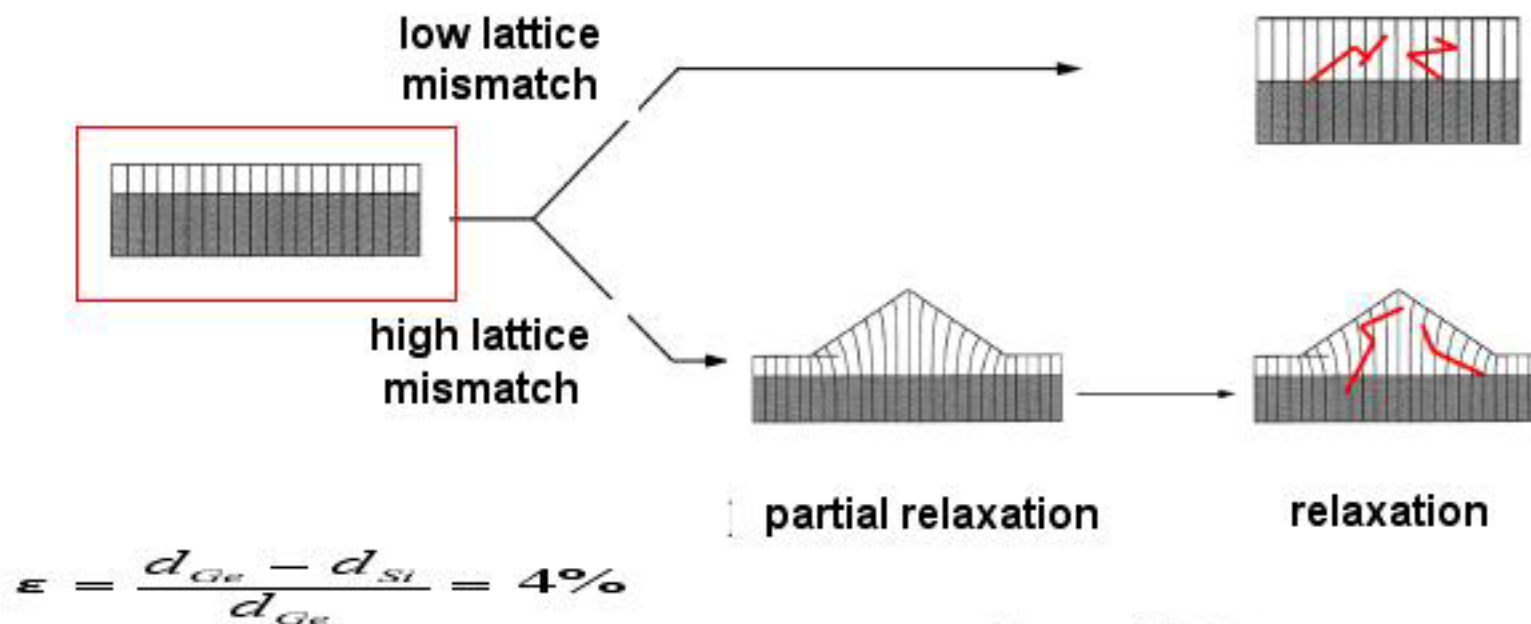
Lattice parameter $\begin{cases} \text{Ge} = 5.65 \text{ \AA} \\ \text{Si} = 5.43 \text{ \AA} \end{cases}$

Lattice Mismatch $\epsilon = \frac{d_{\text{Ge}} - d_{\text{Si}}}{d_{\text{Ge}}} = 4\%$





Evolution of a strained heterostructure



Stranski-Krastanov

- $h < h_0$: Coherent layer-by-layer growth
- $h > h_0$: nucleation of coherent islands



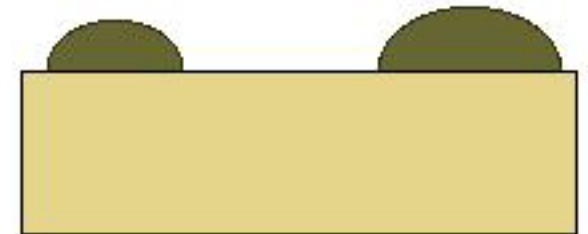


Epitaxial growth modes

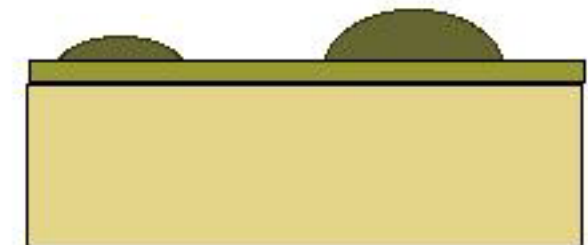
- Frank-Van der Merwe



- Volmer-Weber

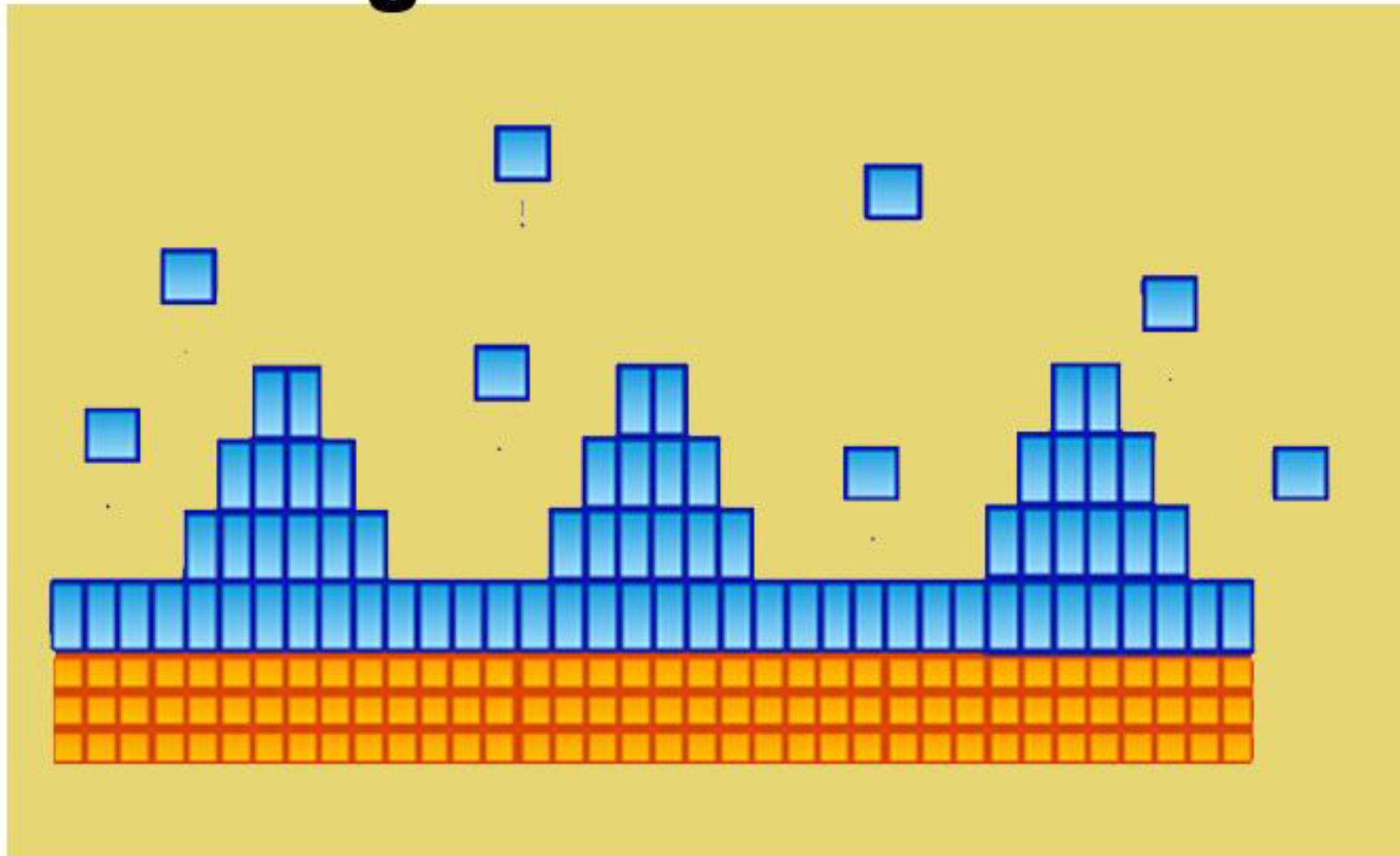


- Stranski-Krastanow



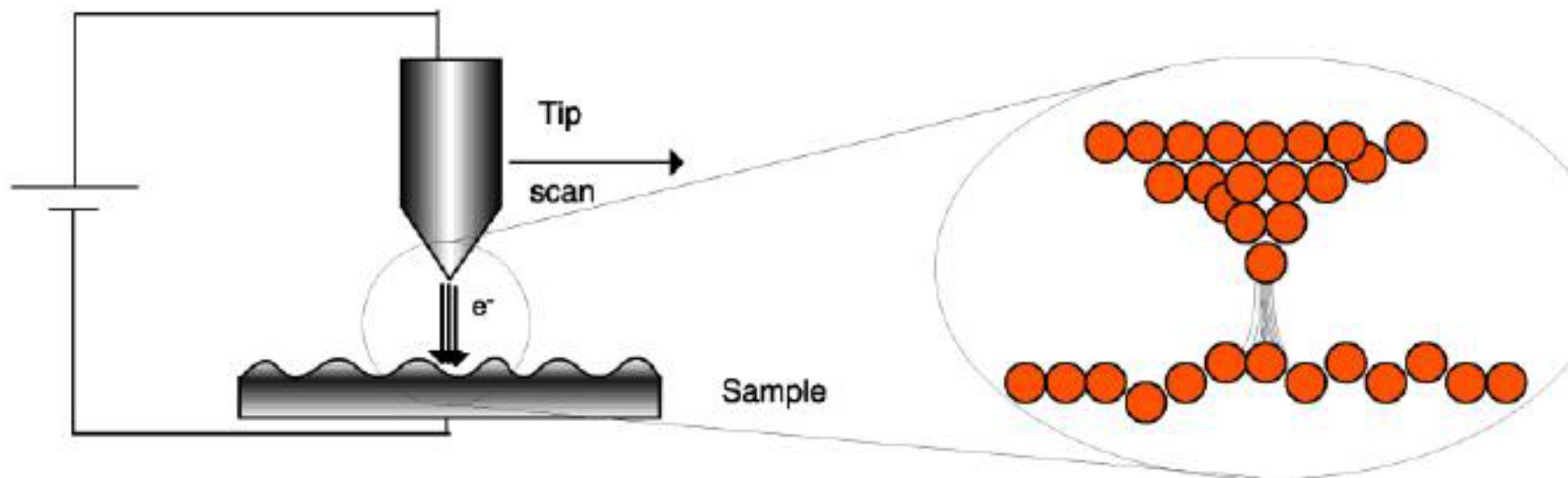


Stranski Krastanov growth mode





Experimental Technique: Scanning Tunneling Microscopy



By putting a metallic tip very close to the surface of a solid, and applying a small bias voltage (0.02-2 V) the electrons can “tunnel” through the vacuum barrier.

This quantum mechanical effect can be exploited to visualize the atoms of a surface because of the exponential behavior of the tunneling current as a function of the tip-sample distance.





VT-STM Lab

INFM-Roma Tor Vergata

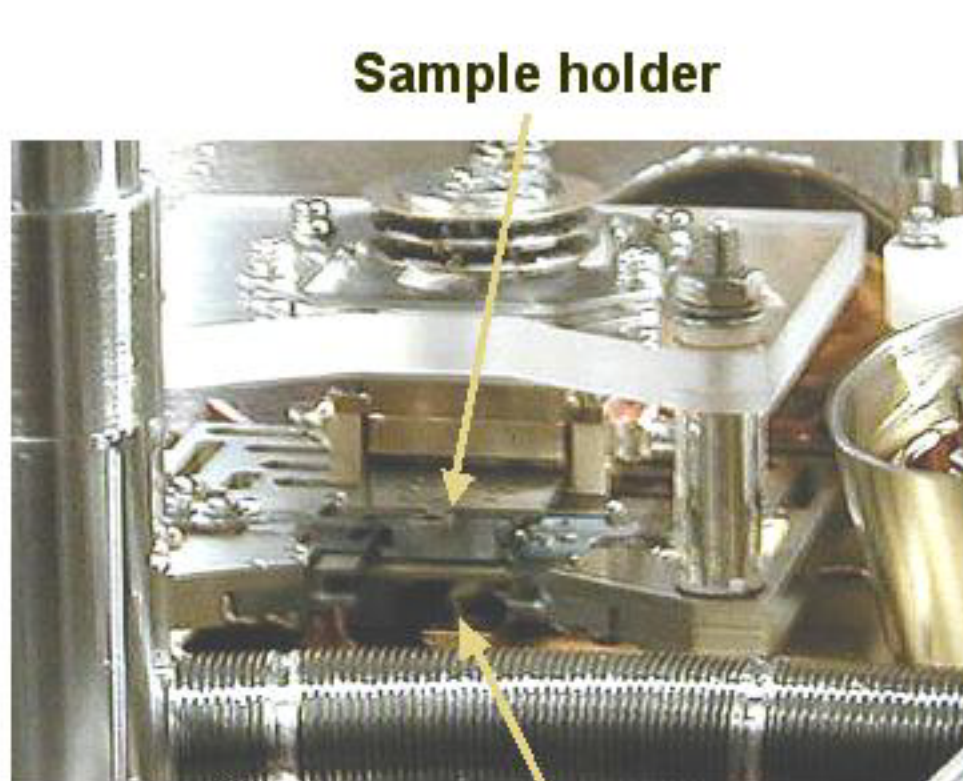




VT-STLab

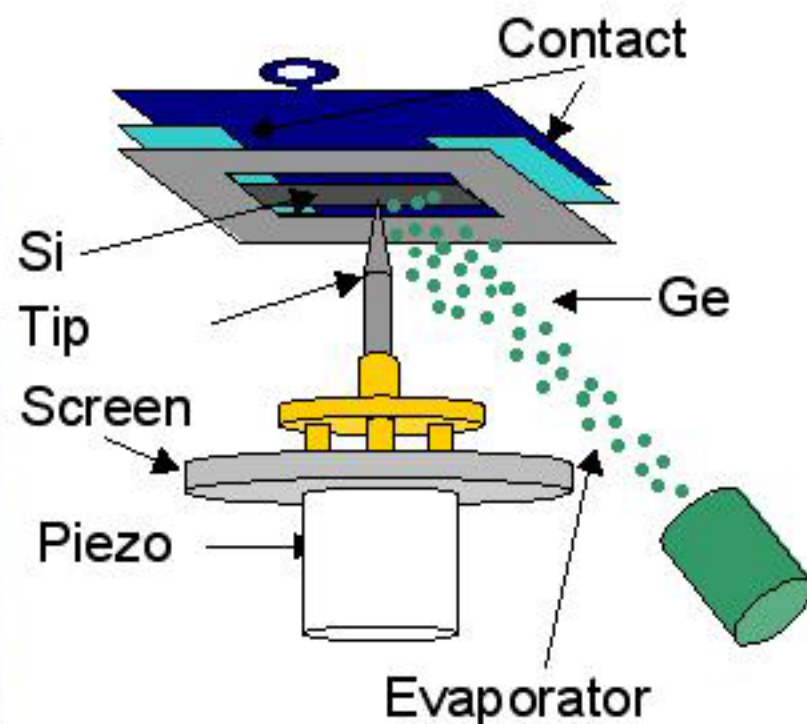
INFM-Roma Tor Vergata

STM with direct current heating (300-1500 K)



Sample holder

Tip





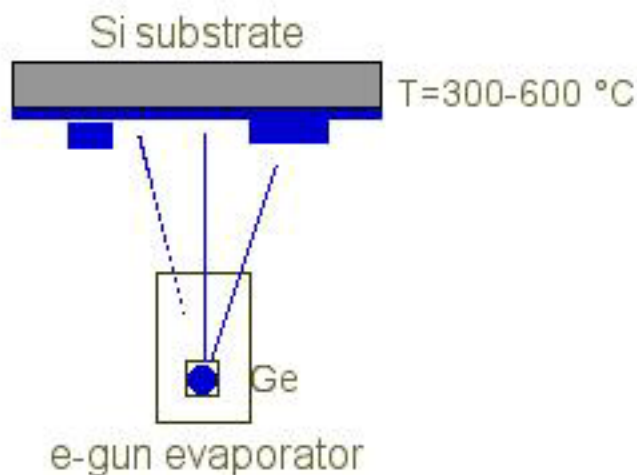
Ge/Si(111) growth

Physical Vapour Deposition

- UHV conditions ($p < 5 \cdot 10^{-11}$ mbar)
 - Si(111) reconstruction: flash at 1250 °C
- E-gun evaporator for Ge
 - Ge flux: 0.1 nm/min
 - Si substrate: $T = 450\text{--}550$ °C

● $\Theta > 3$

• (1



nation

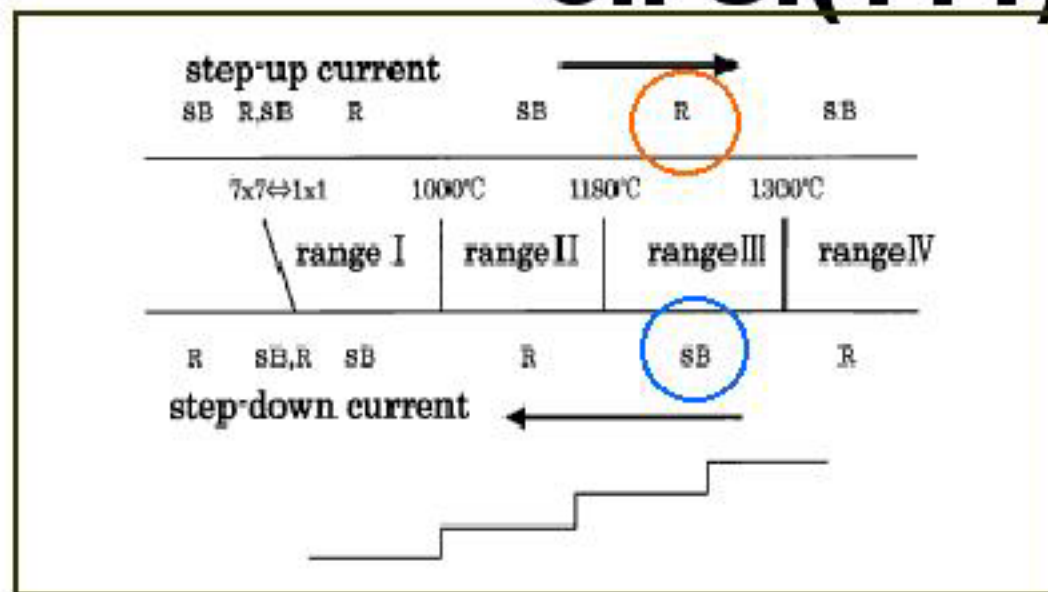
Base Pressure : $5 \cdot 10^{-11}$ mbar

Growth Pressure: $2 \cdot 10^{-10}$ mbar





Effect of the DC heating on Si(111) surface



R = Regular

SB = Step Bunching

H.C. Jeong et al. Surf Sci Rep 34(1999) 171

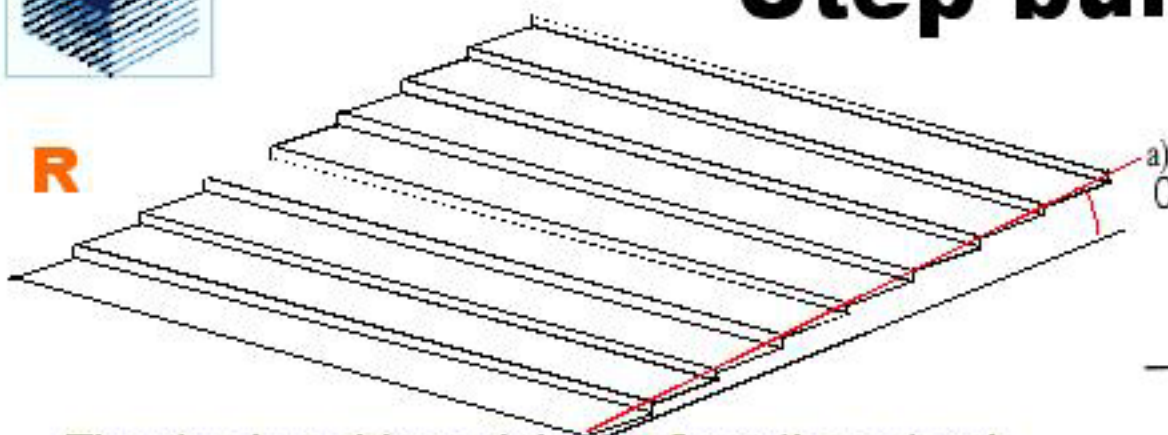
K.Yagi et al Surf Sci Rep 43 (2001) 45



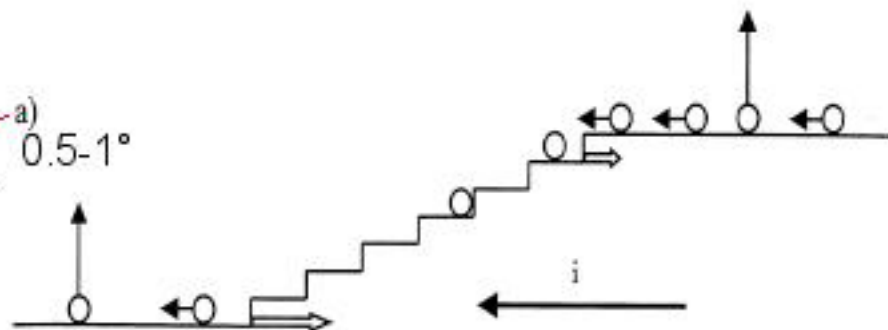


Step bunching

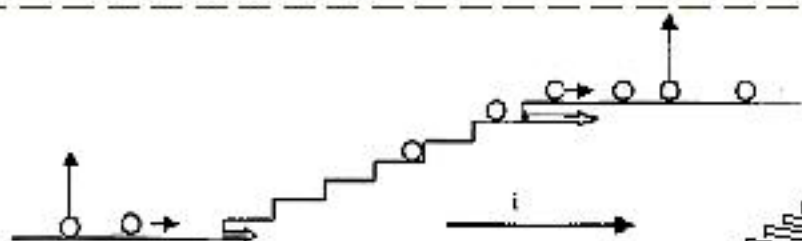
R



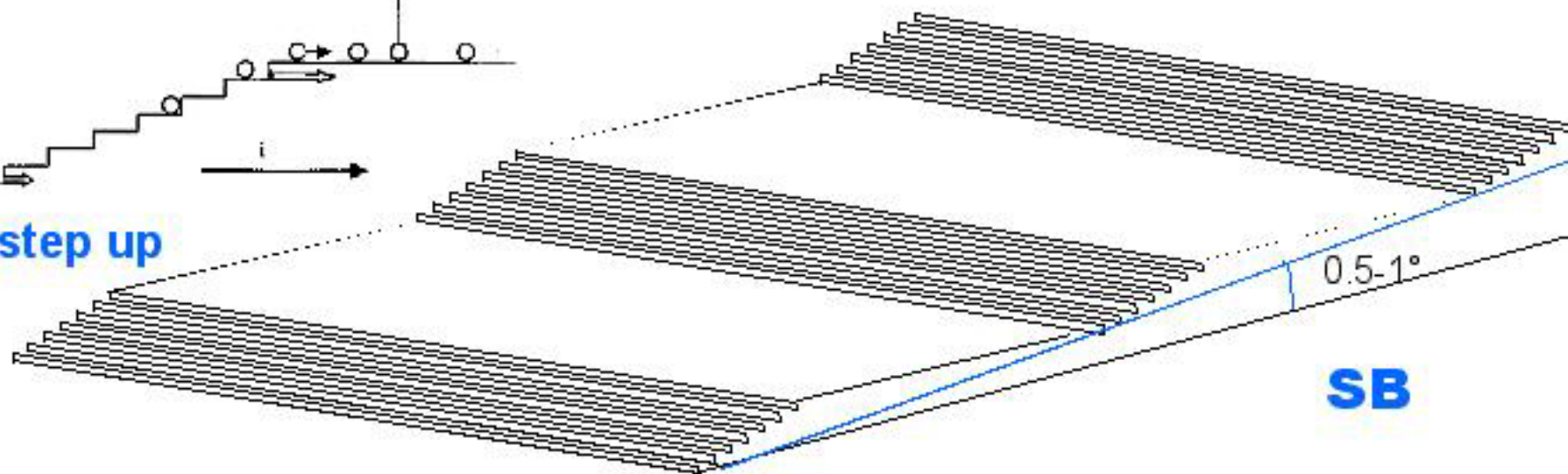
The step bunching originates from the natural steps which are on a surface due to miscut



Current: step down



Current: step up



SB

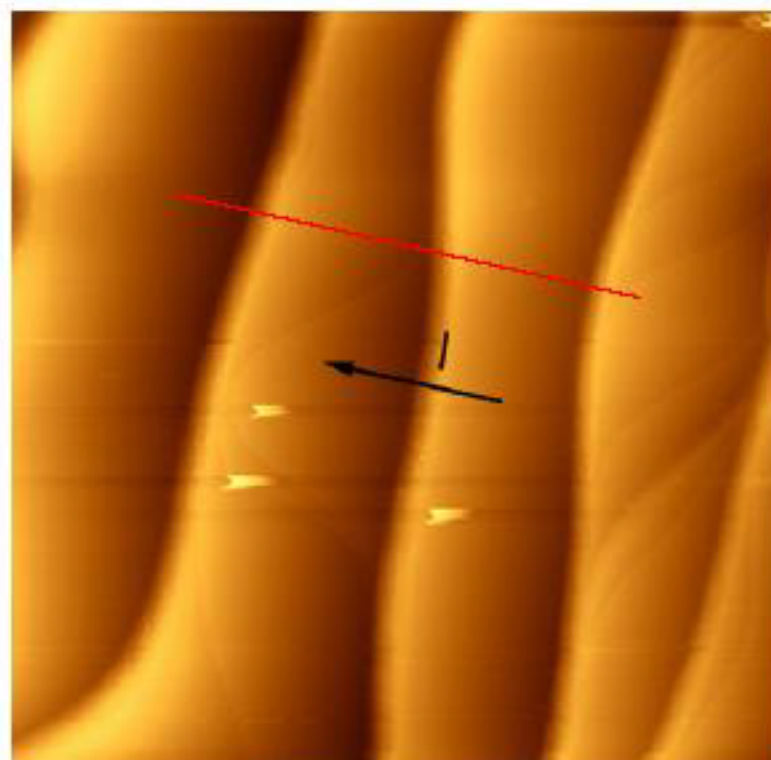
On Si(111) surfaces, during growth or sublimation, the direct current heating can favour the enlargement of some terraces at the expenses of the others



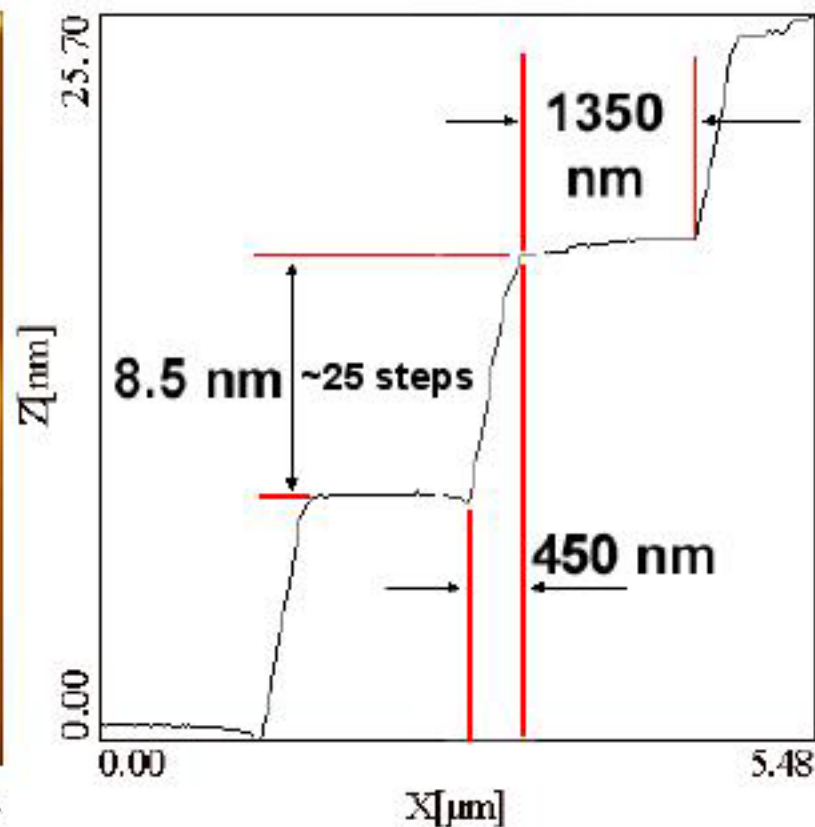


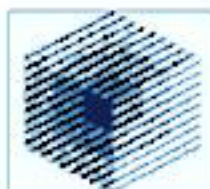
Step bunching: large steps

Flash $T=1250\text{ }^{\circ}\text{C}$ – Current direction: step down



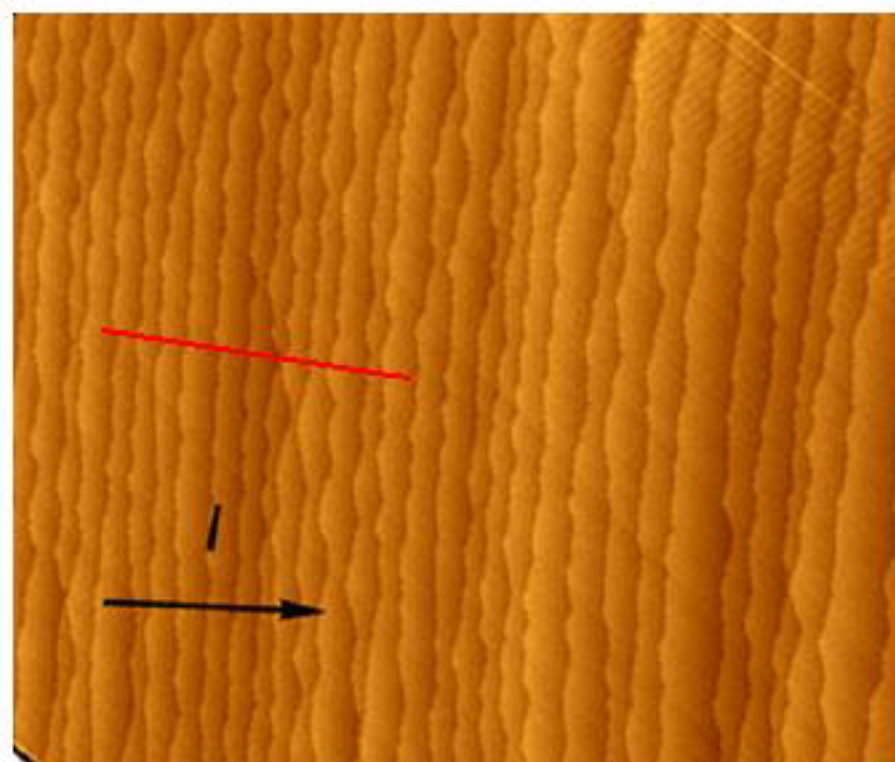
7 μm



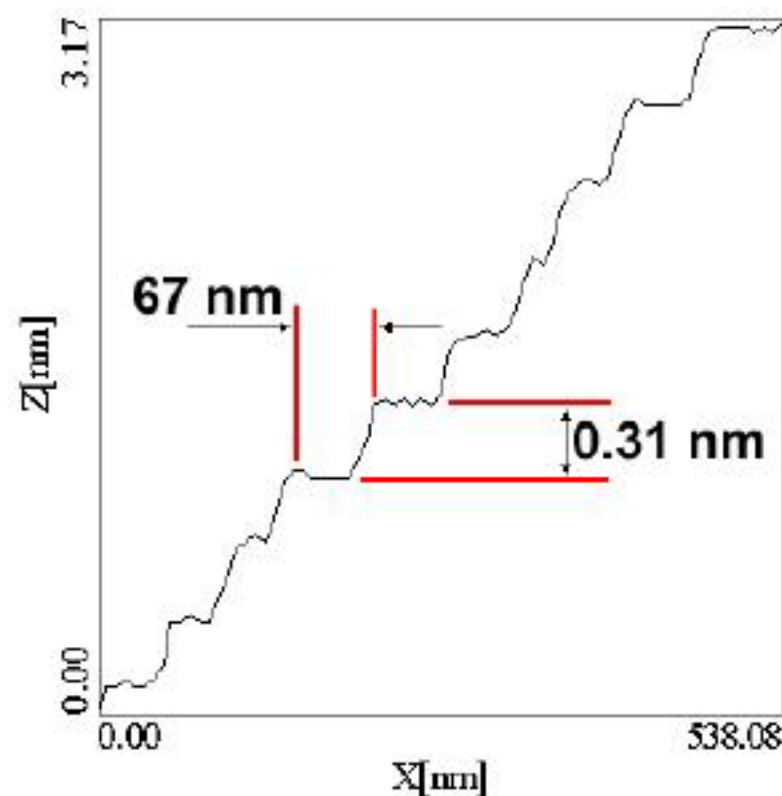


Step debunching: small steps

Flash T=1250 °C – Current direction: step up

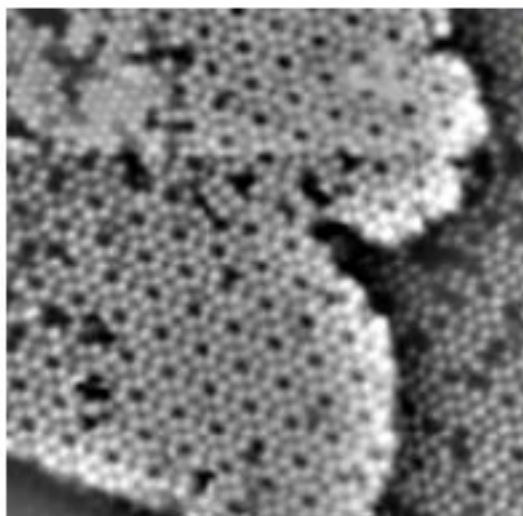
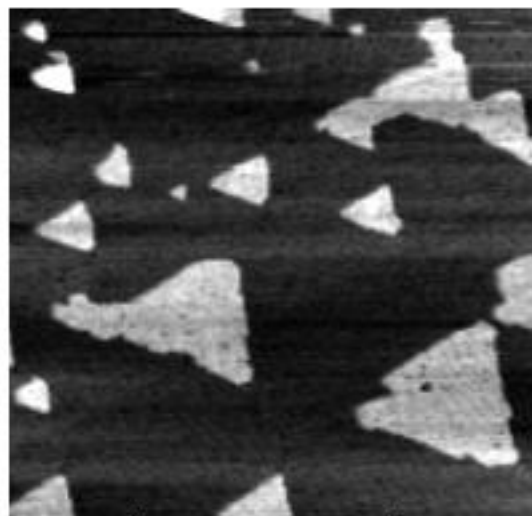


1.7 μm



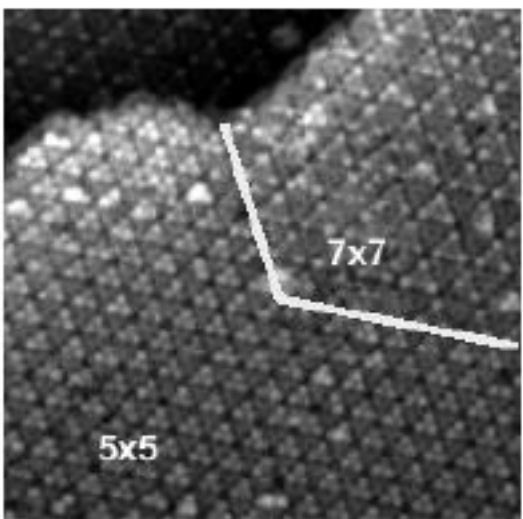
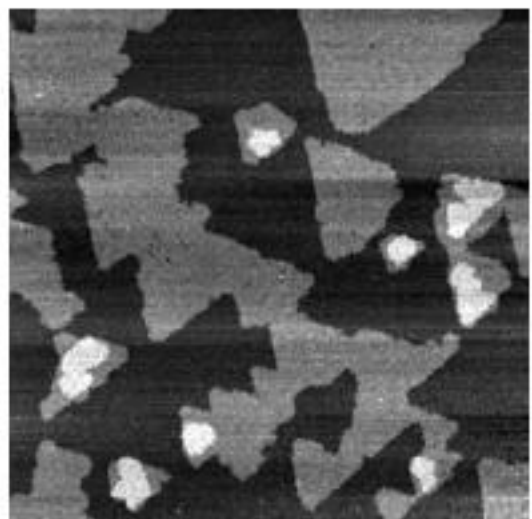


Growth of the wetting layer



Ge/Si(111) $T = 500\text{ }^{\circ}\text{C}$

0.65 ML



1.35 ML

N.Motta et al.
Surf.Sci 406, 254 (1998)

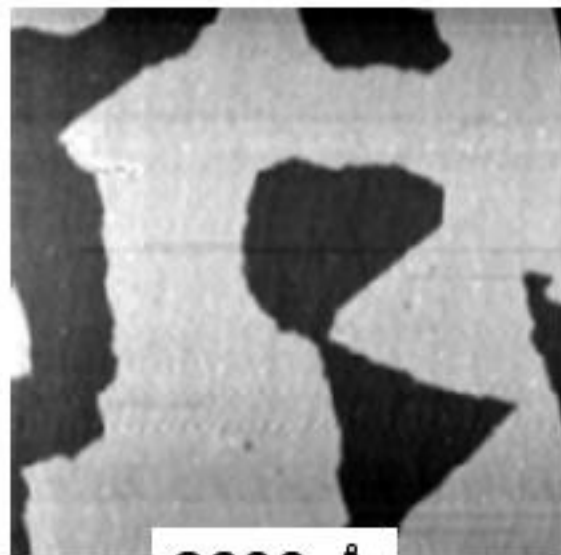
2600 Å

235 Å

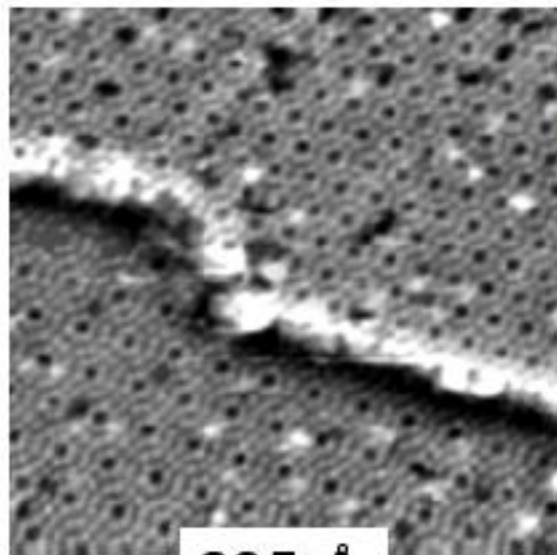




Growth of the wetting layer



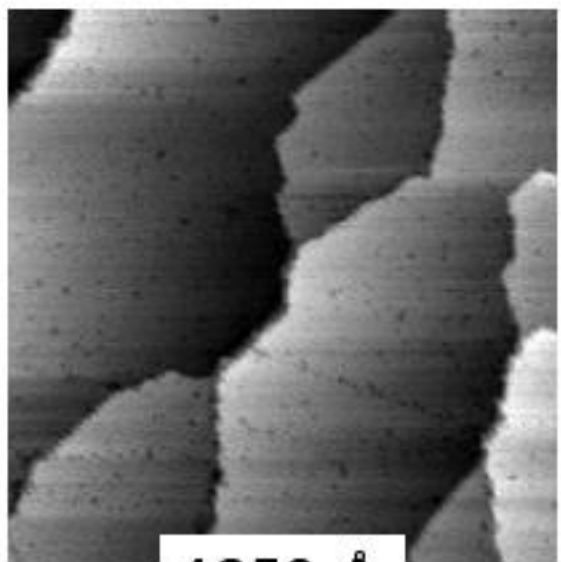
2600 Å



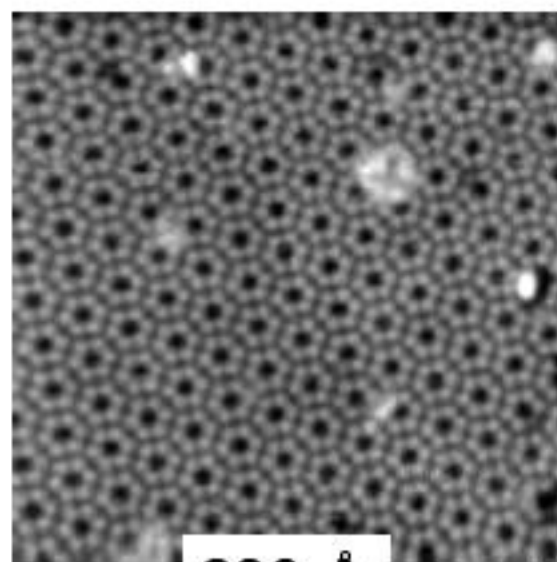
235 Å

Ge/Si(111) T= 500 °C

2.0 ML



1250 Å



230 Å

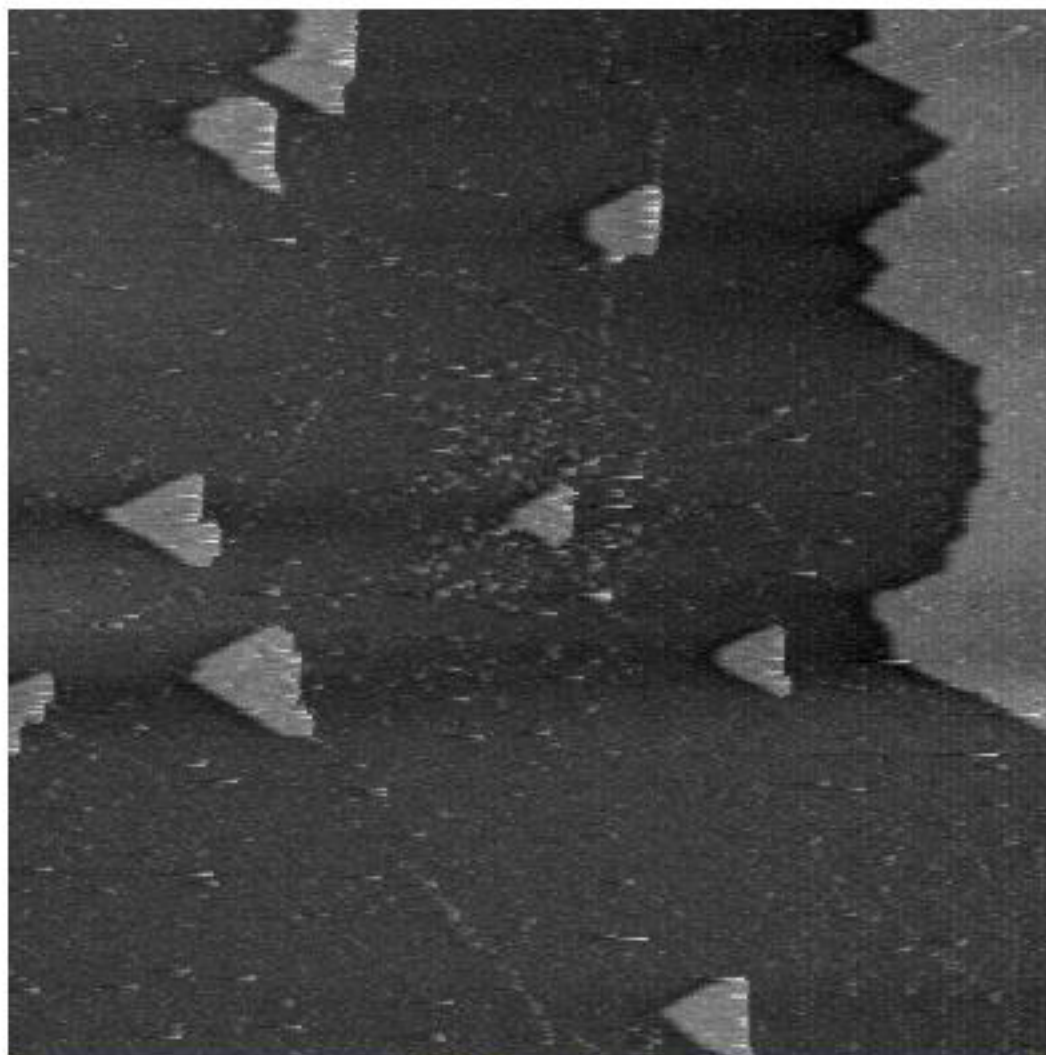
3.0 ML

N.Motta et al.
Surf.Sci 406, 254 (1998)





Growth of the wetting layer



Ge/Si(111)

Flat substrate

$T=400^{\circ}\text{C}$

Ge flux = 0.02 ML/min

Final coverage: 2 ML

Total time: 2h

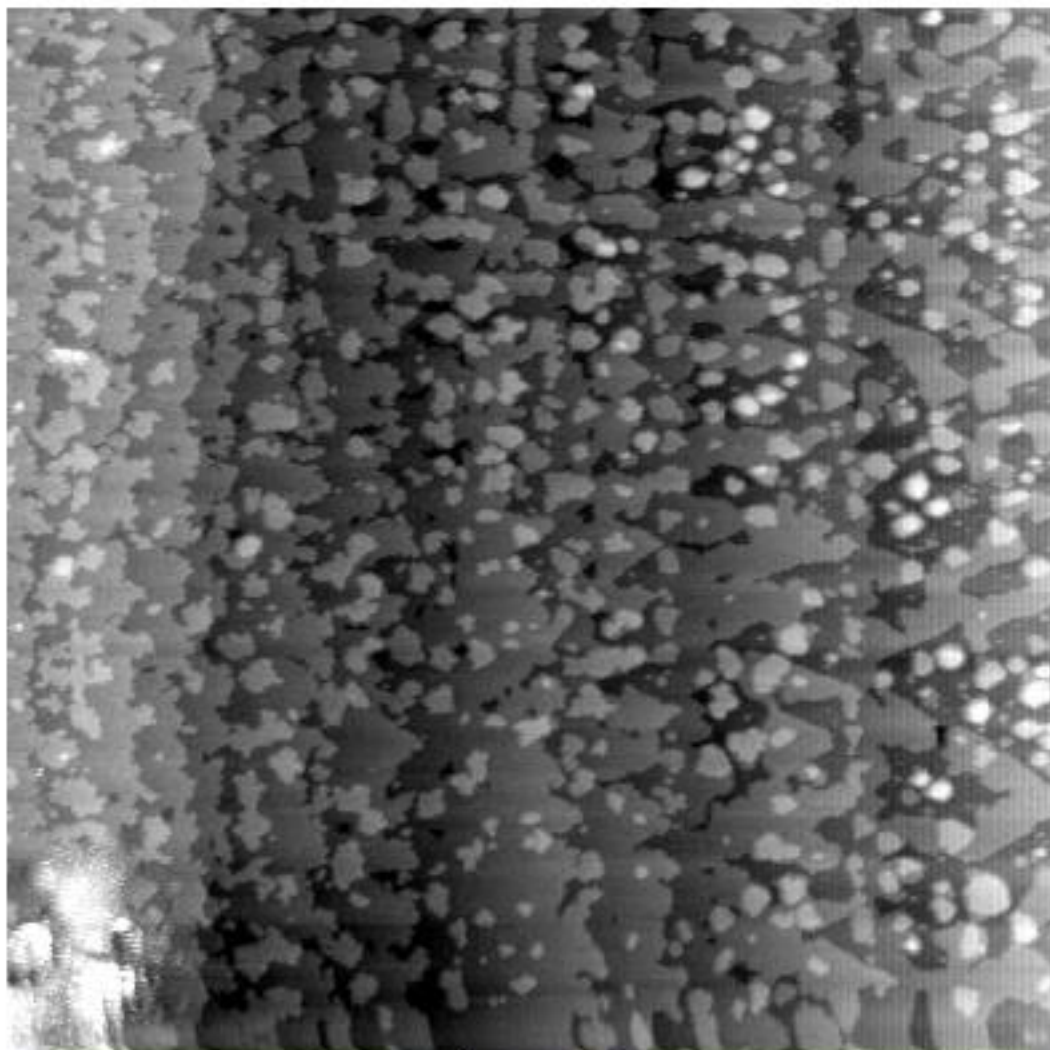
~1 image/min

A.Sgarlata et al: to be published





Growth of the wetting layer



Ge/Si(111)

Stepped substrate

$T=400^{\circ}\text{C}$

Ge flux = 0.15 ML/min

Final coverage: 20 ML

Total time: 1h 30min

~1 image/min

A.Sgarlata et al: to be published



1 μm



Ge/Si(111) 3D growth

2000 nm

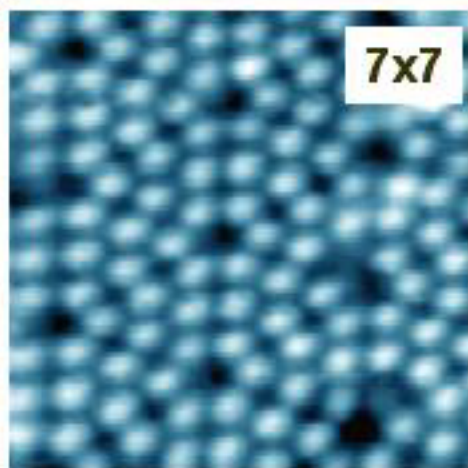


9 ML Ge deposition
0.1 nm/min T=500°C
+ 10' annealing T=500°C

Islands:

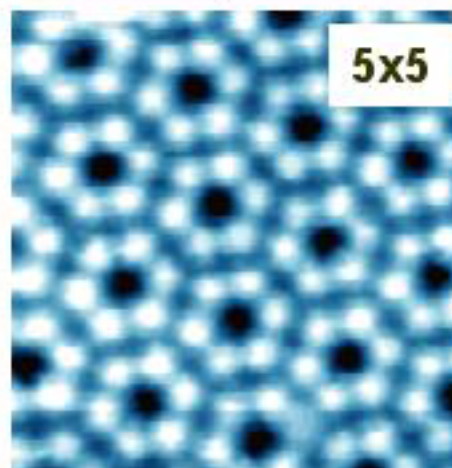
tall – triangular (strained)
(180 nm wide x 40 nm high)

low – rounded (ripened)
(350 nm wide x 2 nm high)



7x7

8 nm



5x5

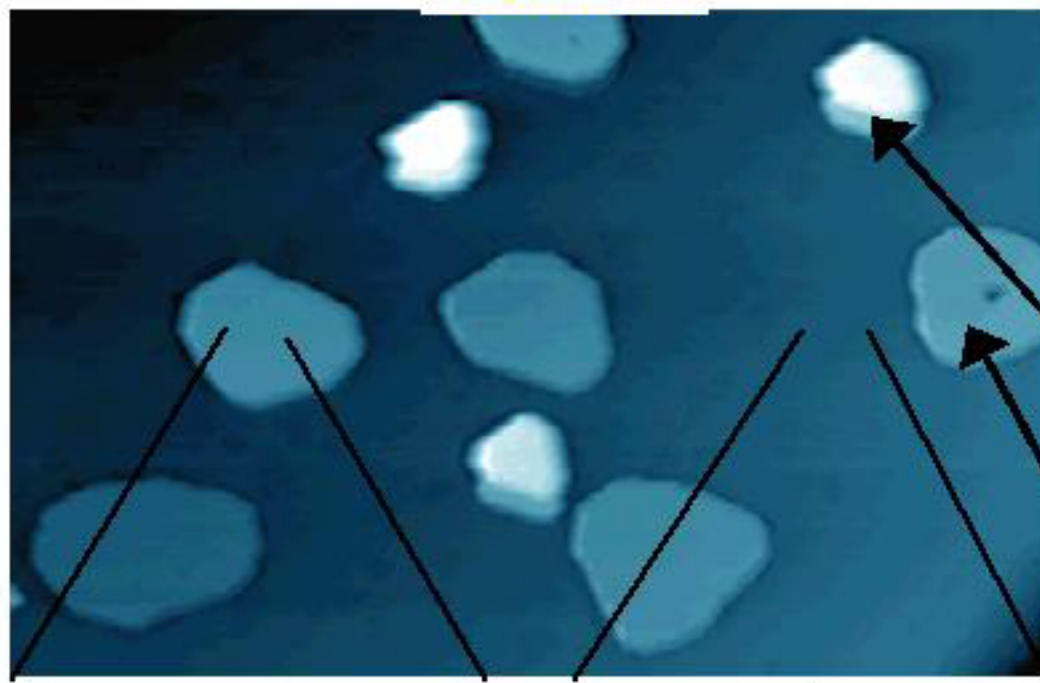


N.Motta et al.
Surf.Sci 406, 254 (1998)



Ge/Si(111) 3D growth

2000 nm

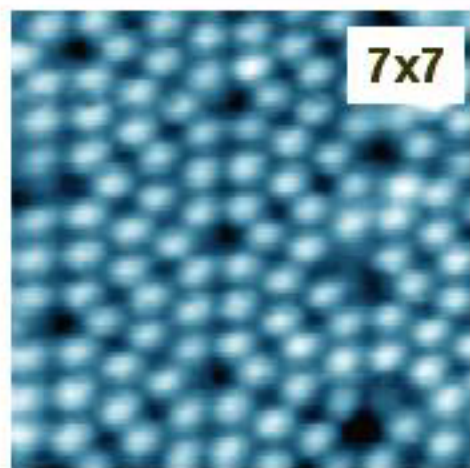


9 ML Ge deposition
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Islands:

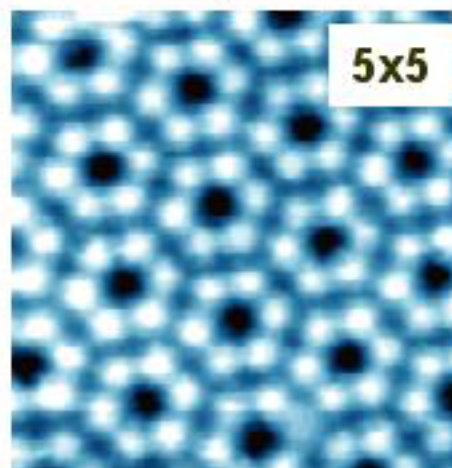
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N.Motta et al.
Surf.Sci 406, 254 (1998)

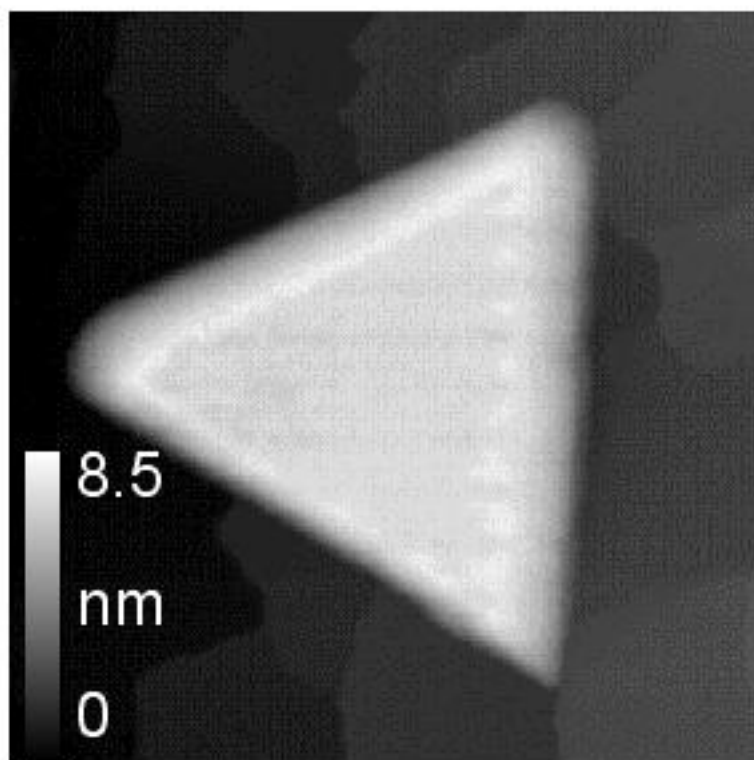




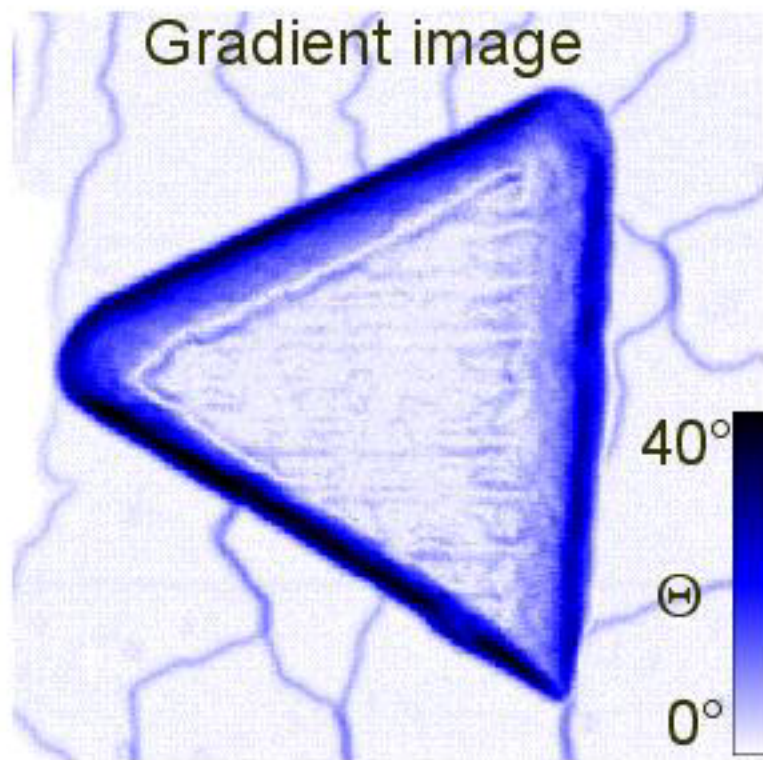
Ge/Si(111) island evolution

I stage: tetrahedra like islands

20 Å Ge/Si(111) T=530°C



236 nm

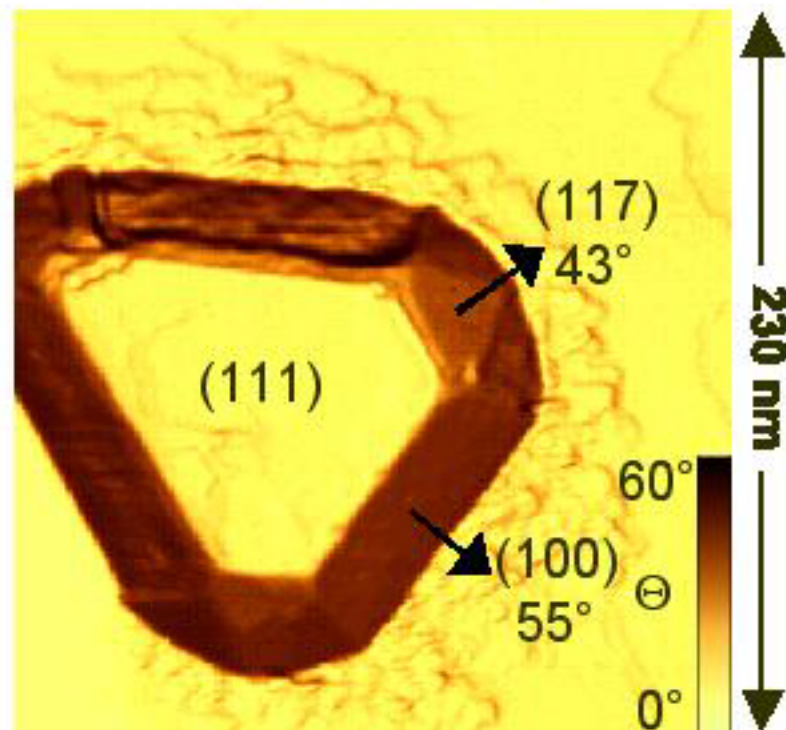




Ge/Si(111): islands evolution

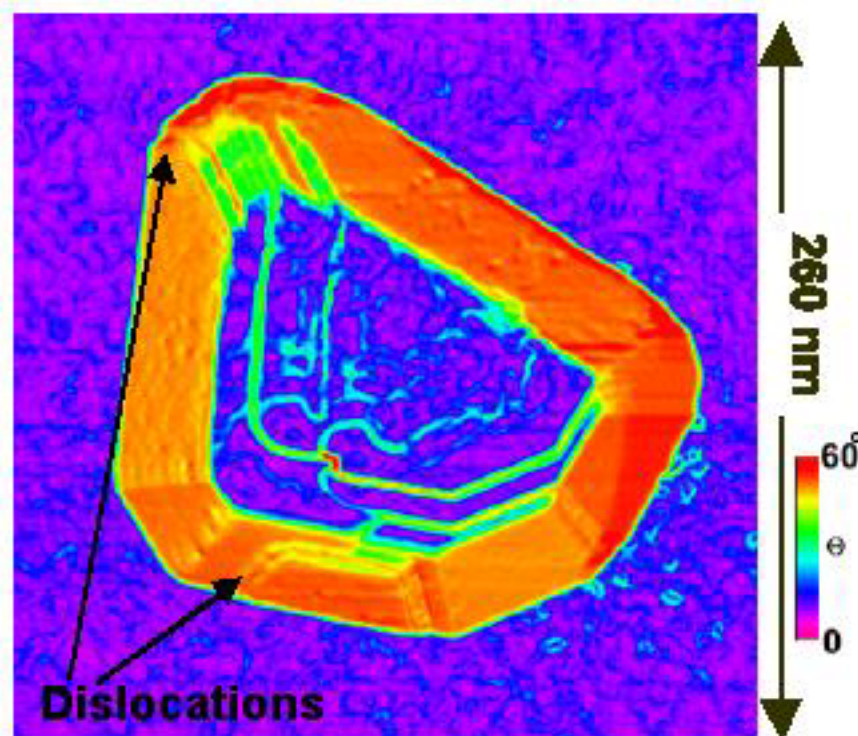
II stage: dislocated islands

25 Å T=450°C



- Island height: 40 nm
- Insertion of new faces: [100] [117]

45 Å T=450°C



- Island height: 63 nm
- Insertion of dislocations

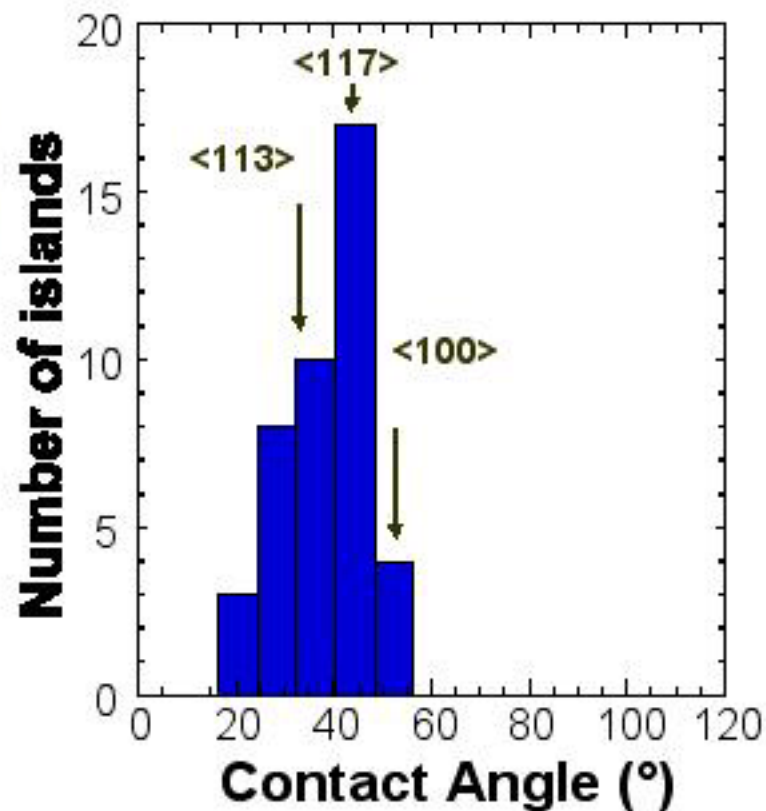




Distribution of the contact angles of the islands with the substrate.

- The histogram shows the insertion of new crystallographic facets.

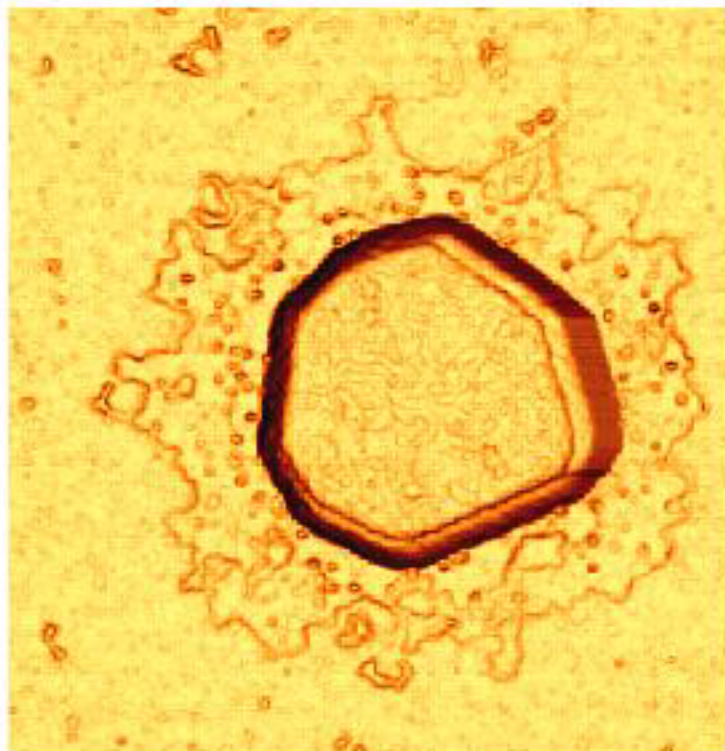
Contact angles of the islands with the substrate for 2.0 nm Ge, $T=530\text{ }^{\circ}\text{C}$





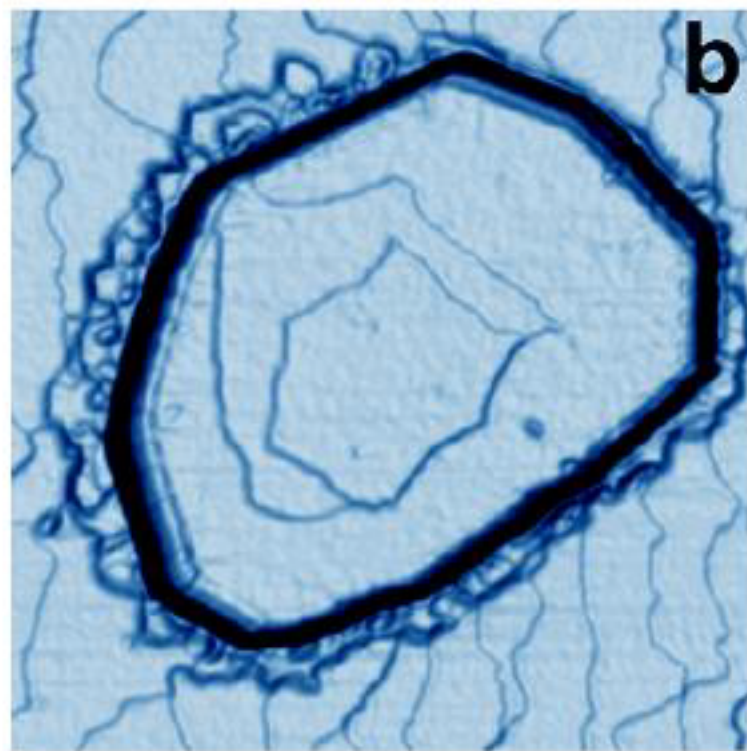
Ge/Si(111): islands evolution “ripening”

3.5 nm T=500°C



500 nm

2.0 nm T=500°C



527 nm

- Island height: 10 nm
- Substrate erosion: 1 nm

- Island height: 5 nm
- “Atoll” formation

N.Motta et al. S. S. Comm. (1999). F.Boscherini et al. APL (2000)

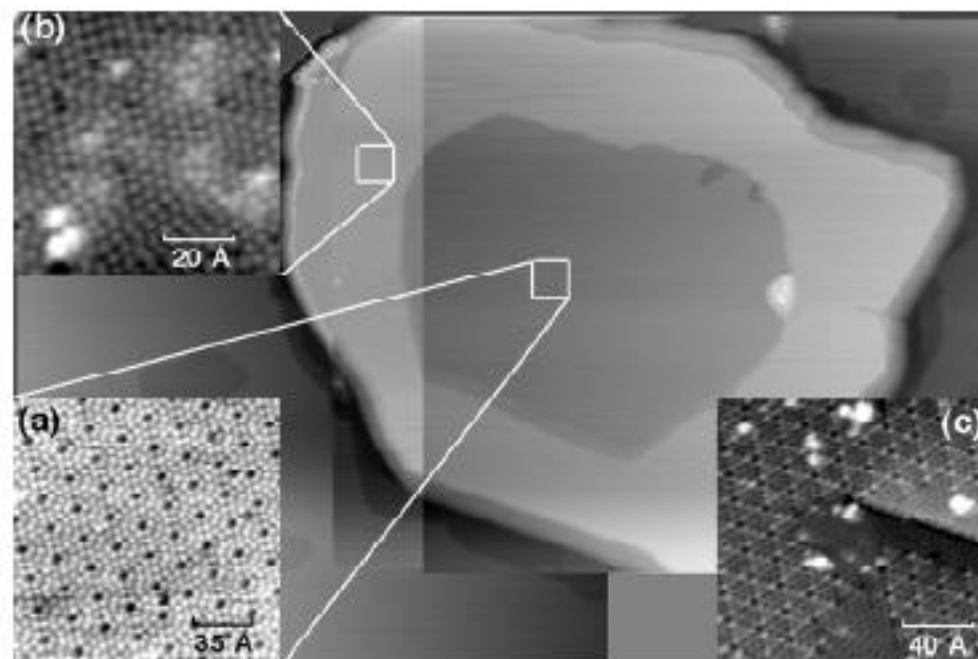




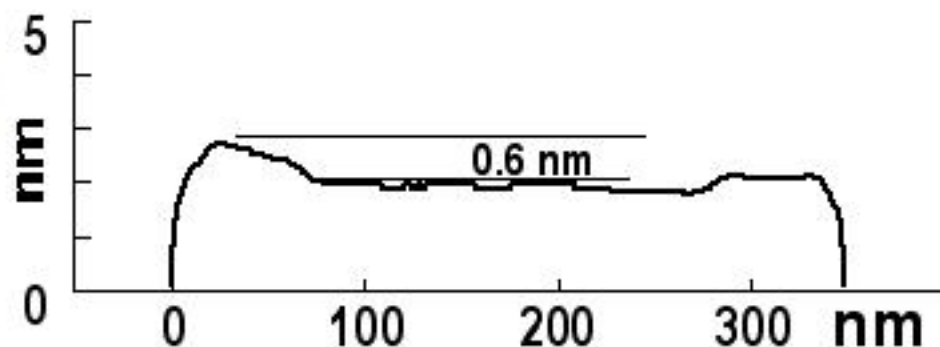
Ge/Si(111) island evolution

● After the nucleation:

- the islands grow vertically up to a critical value
- the strain energy introduces dislocations
- morphological transition
- lateral growth
- material flow from the top - central hole formation



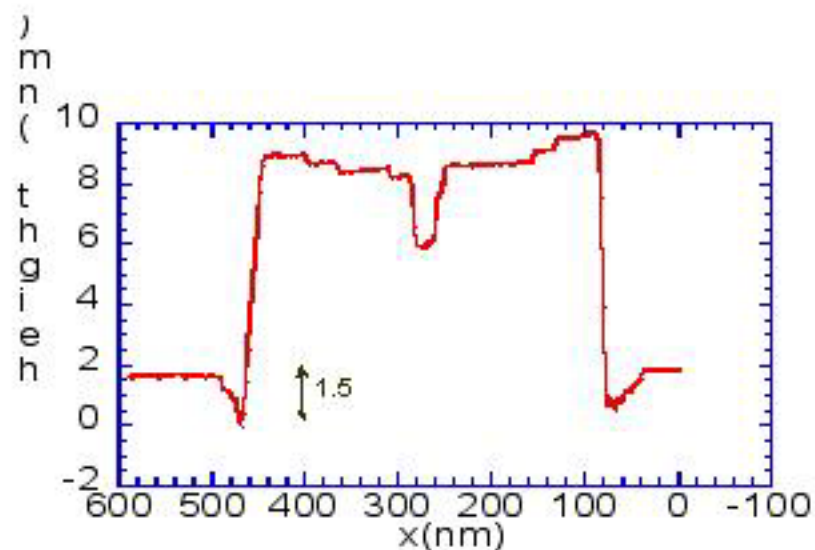
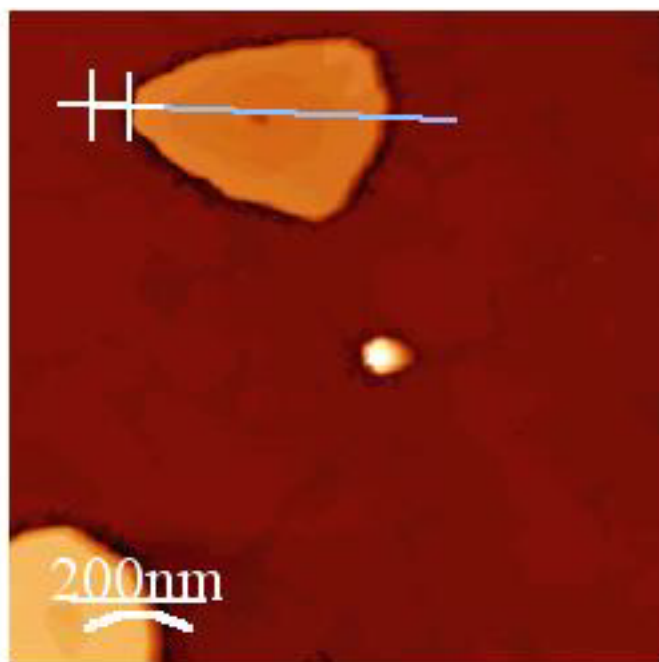
800 nm





Ge/Si(111): islands evolution analysis of the trench

2.5 nm Ge T=450°C

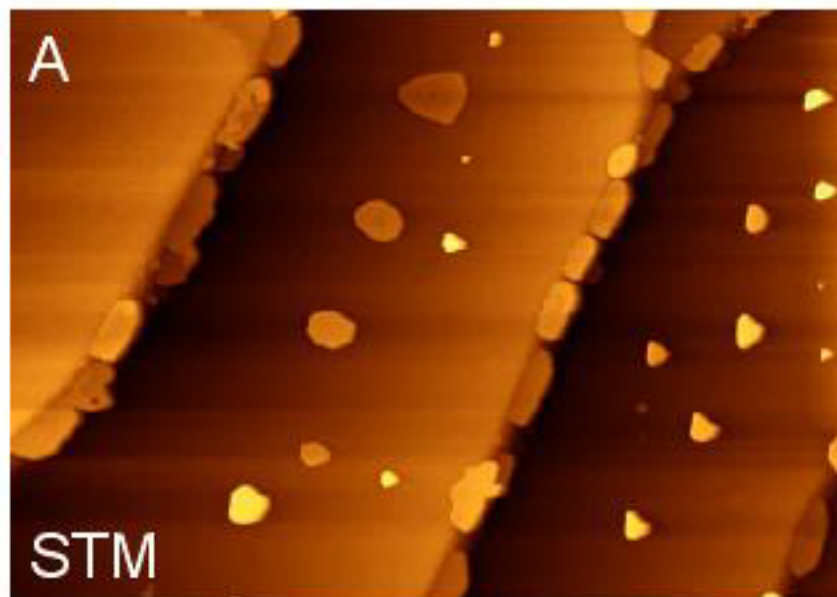




Ge/Si(111) island distribution

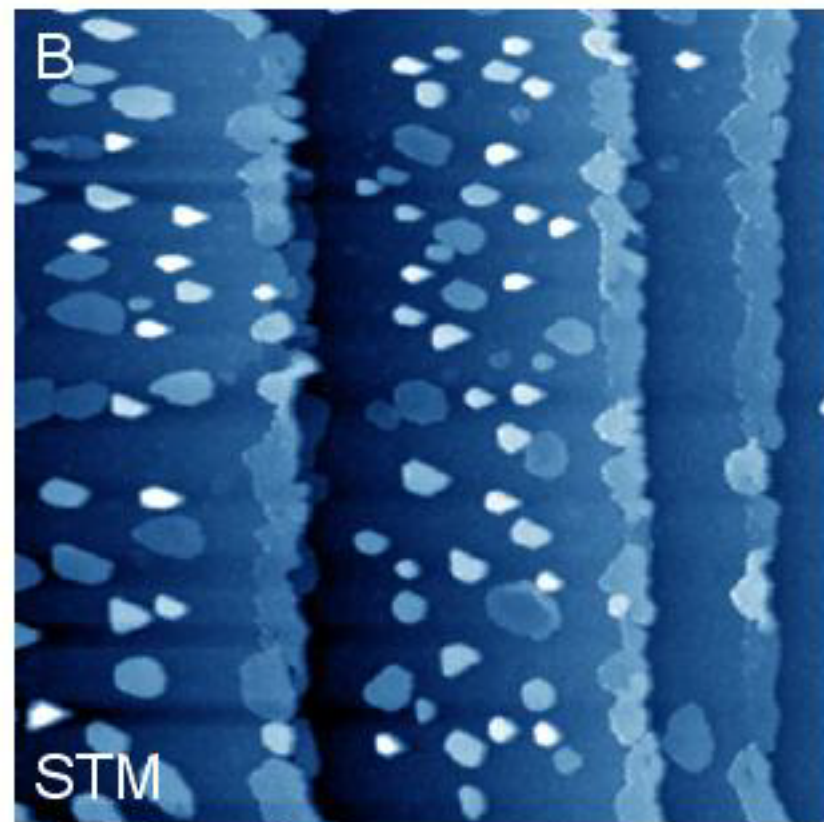
25 Å Ge/Si(111) T=450°C

60 Å Ge/Si(111) T=450°C



← 3.7 μm →

A) First - second generation of islands:
spacing controlled by diffusion coefficient



← 10 μm →

B) Third - fourth generation of islands.





Distribution of island distances on terraces

● 25 Å Ge - T = 450 °C

● Terrace width: 1.0 ÷ 1.2 μm

● Island-to-step distance :

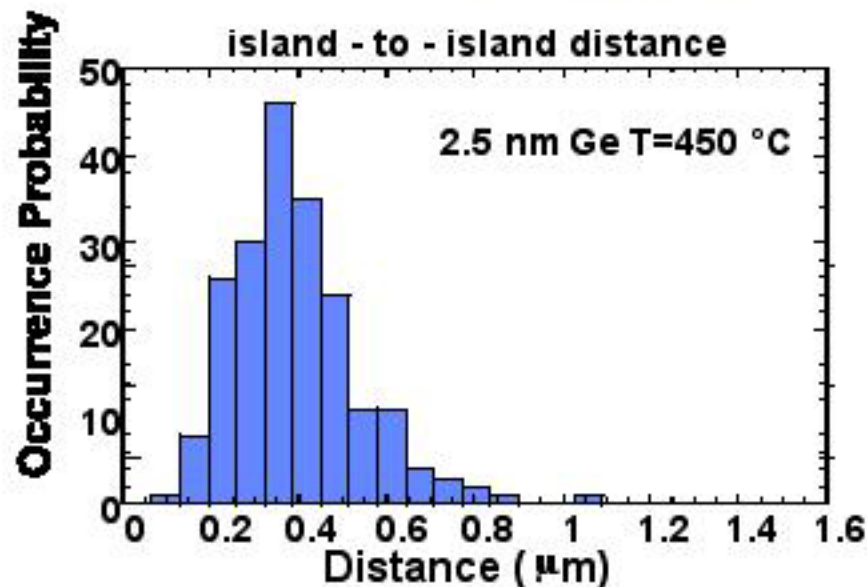
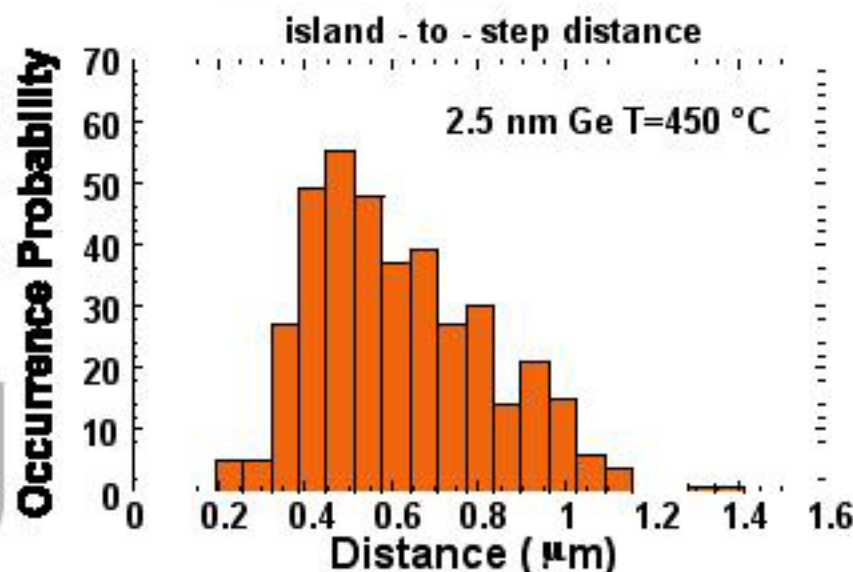
– $D_{i-s} = 0.62 \mu\text{m}$

• $\sigma = 0.21 \mu\text{m}$

● Island-to-island distance:

– $D_{i-i} = 0.39 \mu\text{m}$

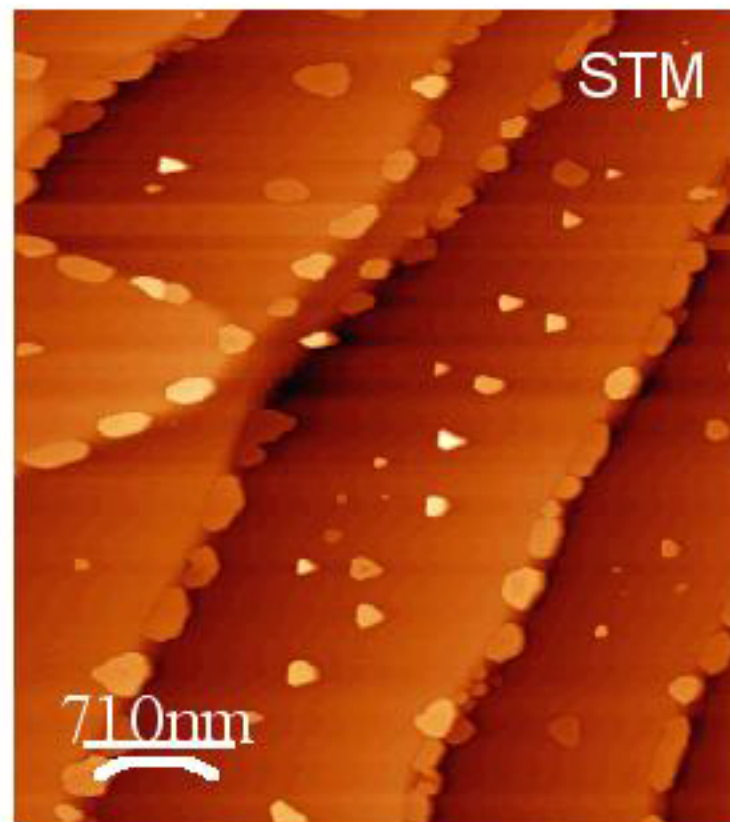
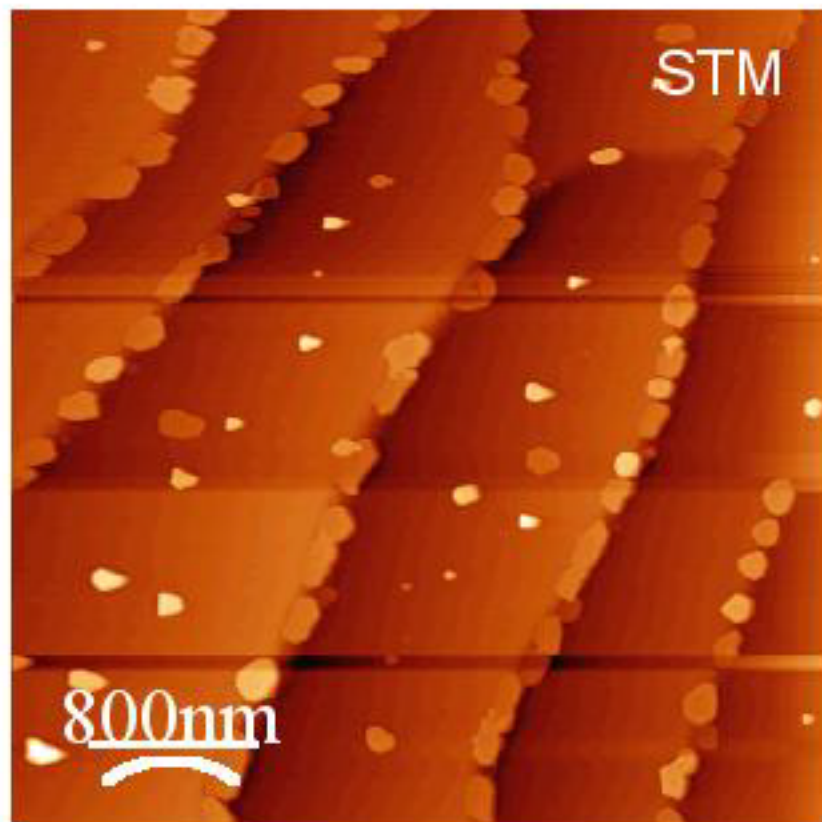
• $\sigma = 0.14 \mu\text{m}$





Ge/Si(111) island distribution

25 Å Ge/Si(111) T=450°C





Ge/Si(111) island distribution

25 Å Ge/Si(111) T=450°C

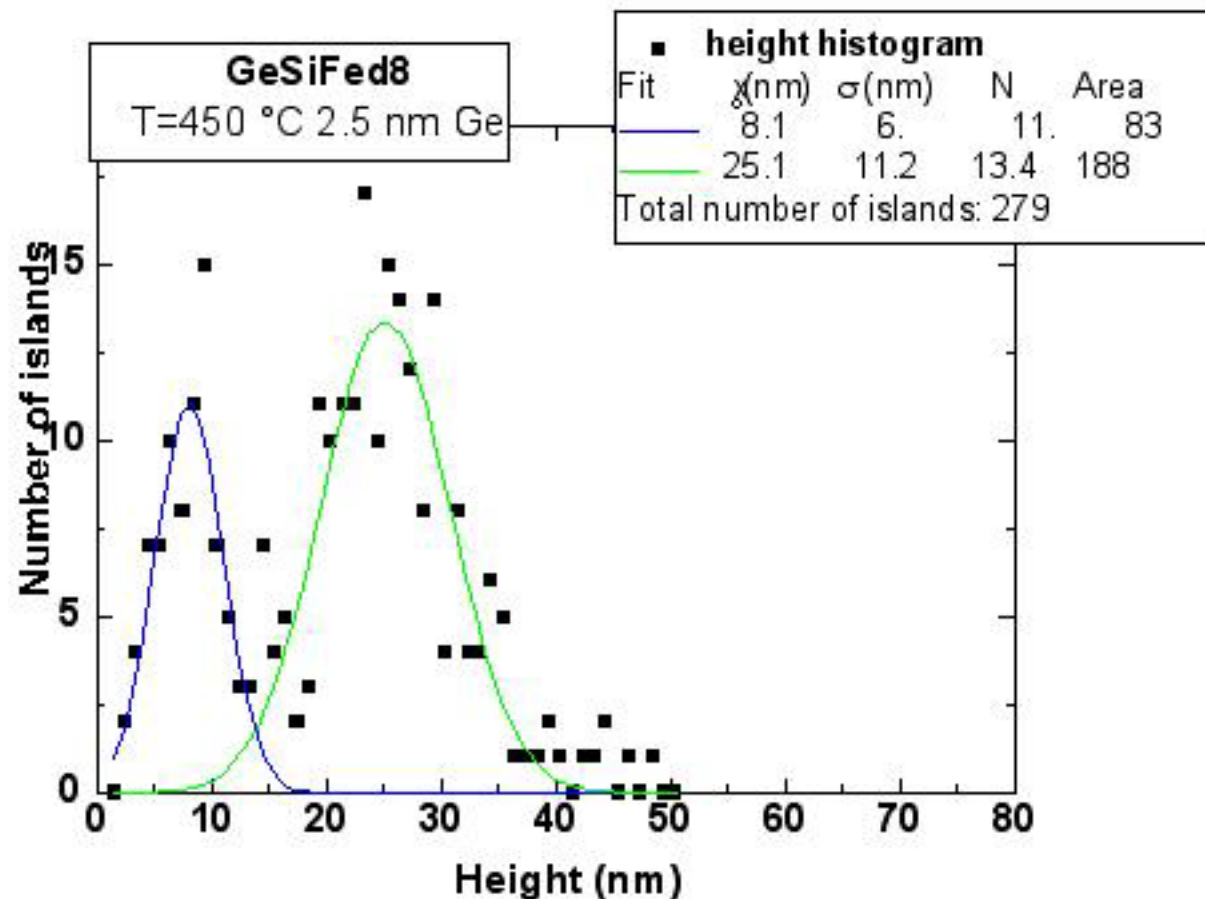
Two main peaks

Dislocated

Relaxed

Small peak

coherents





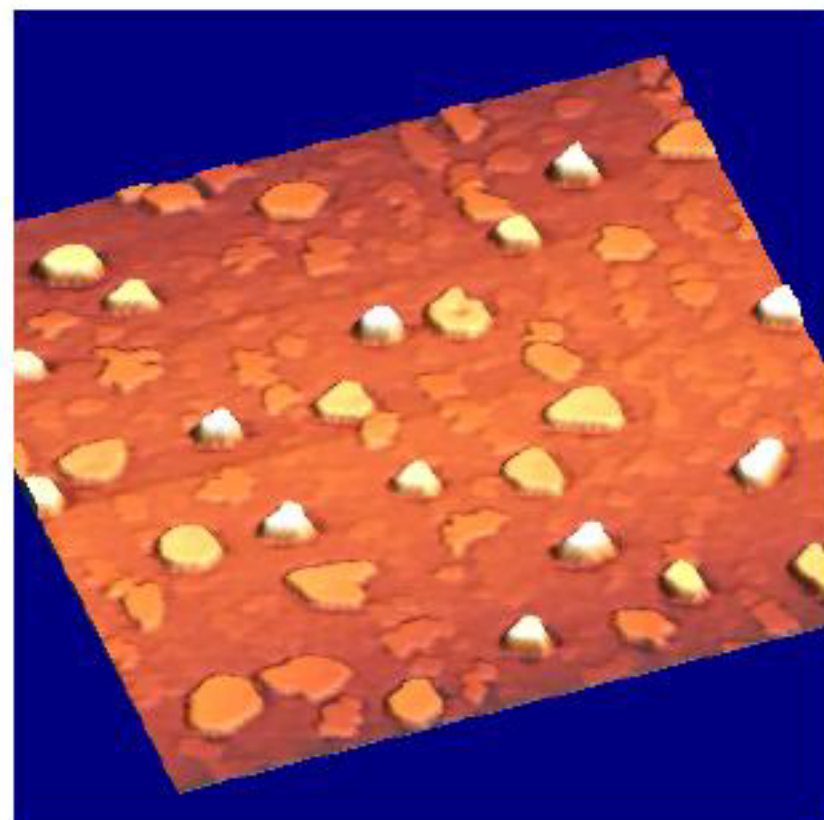
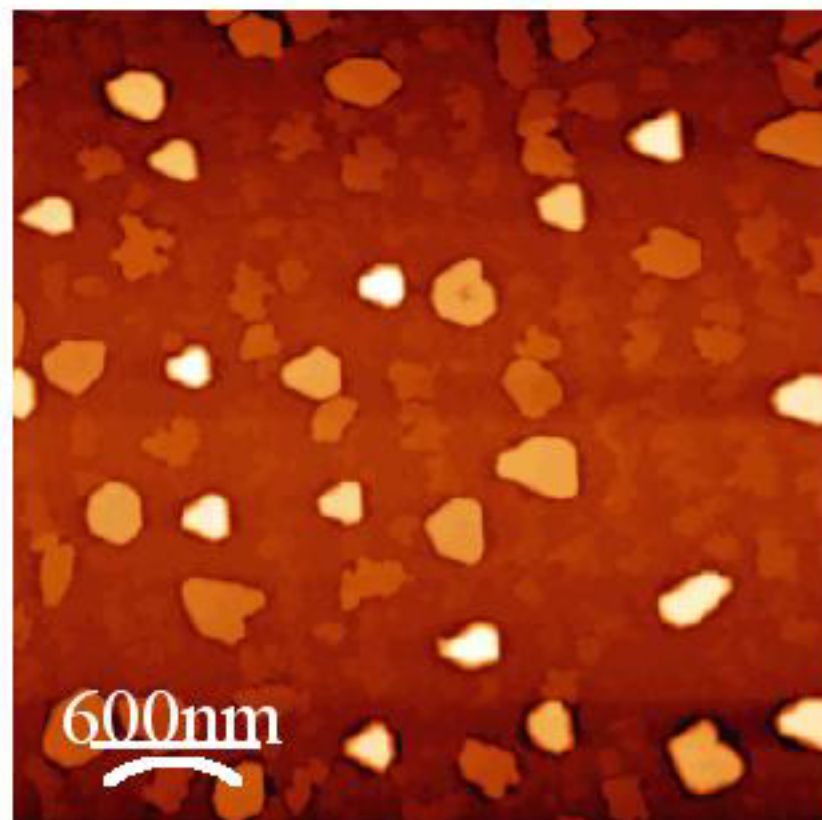
Ge/Si(111) island distribution

70 Å Ge/Si(111) T=500°C

- Distribution of the islands on a substrate with small steps

Δz : 29 nm

3 μm

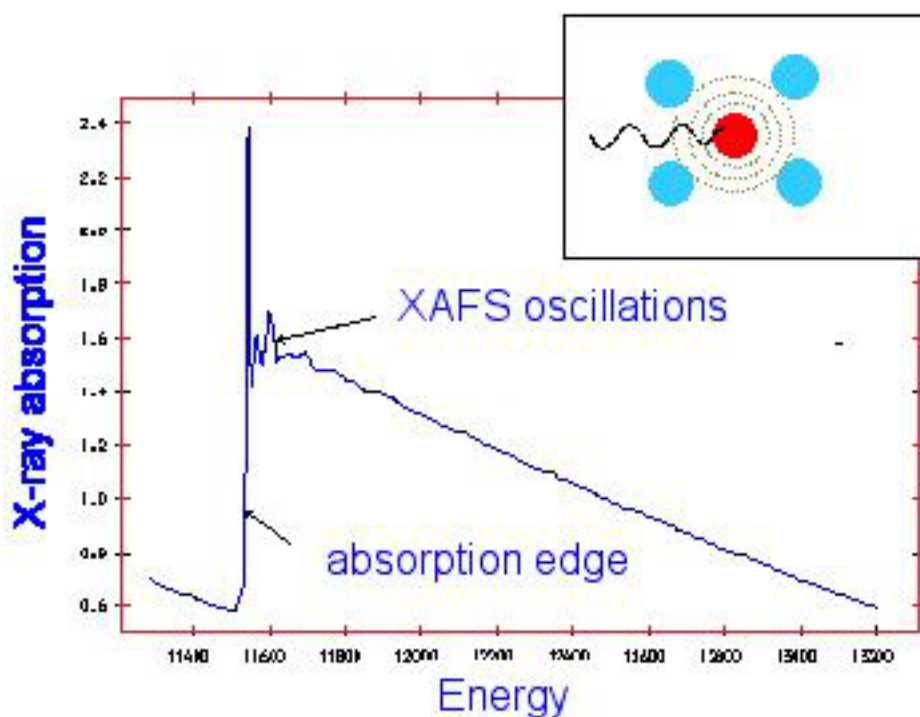




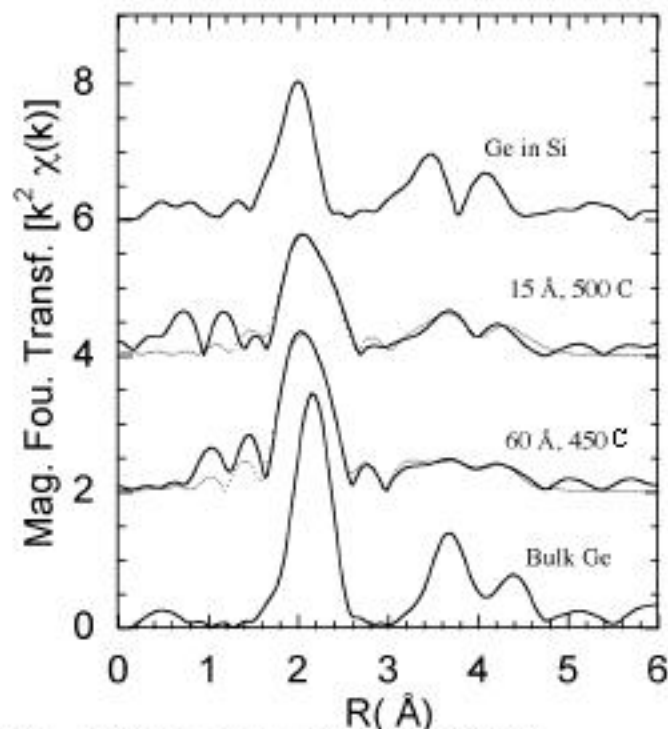
Intermixing measured by XAFS

● X-ray Absorption Fine Structure

- The oscillations of the absorption coefficient after an absorption edge are connected to the distance and to the number of neighbours of the absorbing atom.
- By measuring the number of Si atoms around the Ge site we are able to evaluate the intermixing



Radial Distribution Function
around the Ge atoms



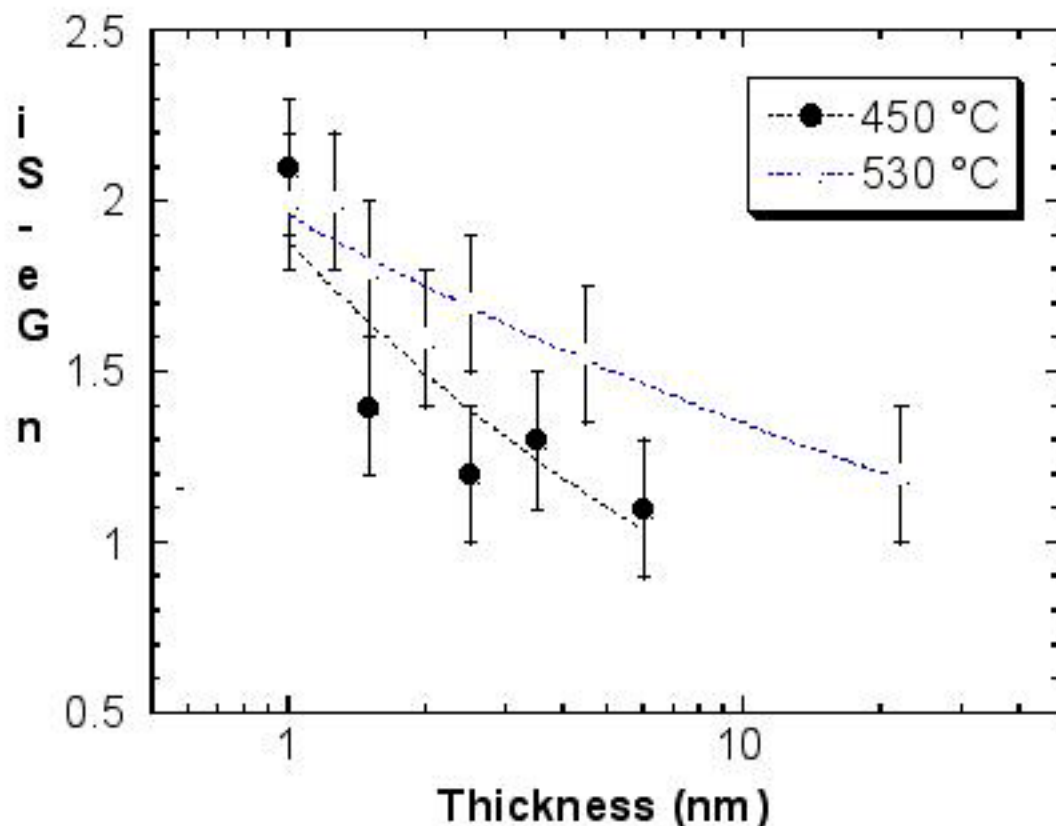
Measurements performed at the GILDA beam line - ESRF



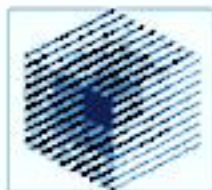


Intermixing measured by XAFS

- Formation of a random alloy in the wetting layer and in the islands of Ge/Si(111)
- Decrease of the number of Si around a Ge ($n_{\text{Ge-Si}}$) as a function of thickness
- Increase of $n_{\text{Ge-Si}}$ as a function of substrate Temperature.



The intermixing increases with T, but is limited in the 3D islands



The future...

Projet FORUM-FIB (CEE 2001-2004)

CRMC2-Juelich-INSA-Demokritos-Philips-ST-Uniroma2

- - **“Patterning” of the substrate through new techniques**

- Lithography
- Ion gun focalized



- Nucleation and growth of ordered array of QD



- New Single Electron devices



- And...





Results

- **Step bunching on Si(111):
preparation of the substrate with
different morphologies**

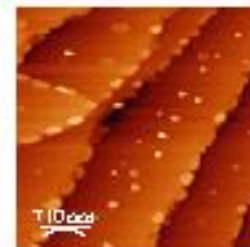
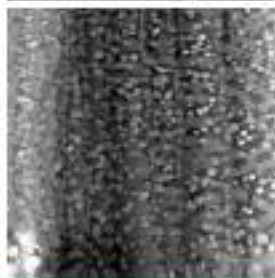
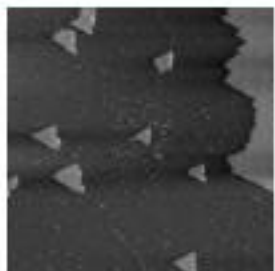


7 μm



1.7 μm

- **Visualization on-line of the
growth of the Wetting Layer**
- **Evolution and distribution of the
3D islands**



Results

- **Step bunching on Si(111):**
preparation of the substrate with different morphologies



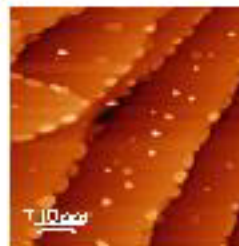
7 μm



1.7 μm

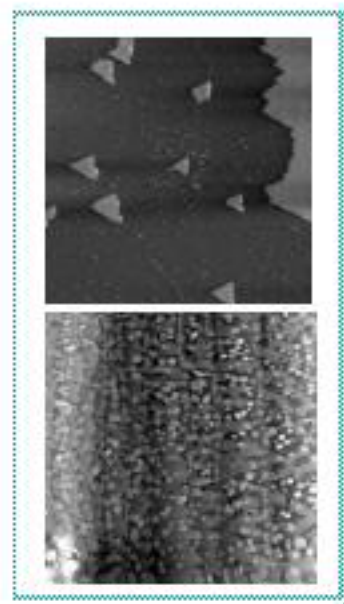
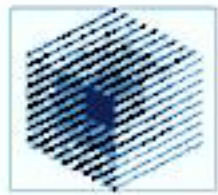
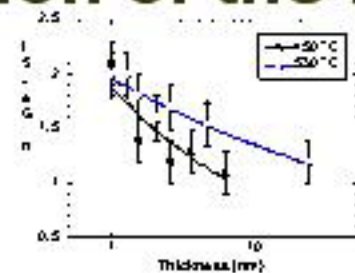
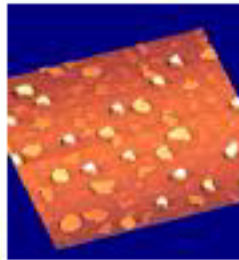
- **Visualization on-line of the growth of the Wetting Layer**

- **Evolution and distribution of the 3D islands**



1.0 μm

- **Evaluation of the intermixing by XAFS**





Conclusions

➤ **Determination of the contribution of the substrate morphology on the heteroepitaxial growth during the formation both of the wetting layer and of the 3D islands**

➤ **Evaluation of the degree of ripening of the 3D islands in different experimental conditions**





Collaborators

Prof. A. Balzarotti

Prof. F. Patella

Prof. M. Fanfoni

Prof. N. Motta

• Dr. A. Sgarlata

• Dr. M. Scarselli

• Dr. F. Rosei

• Dr. S. Nufiris

VT-STM lab –

<http://www.roma2infm.it/infm/nanolab>

